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Published in:
Integrated Optics: Devices, Materials, and Technologies XXIII

Link to article, DOI:
[10.1117/12.2508565](https://doi.org/10.1117/12.2508565)

Publication date:
2019

Document Version
Publisher's PDF, also known as Version of record

[Link back to DTU Orbit](#)

Citation (APA):
El Dirani, H., Kamel, A., Casale, M., Kerdiles, S., Monat, C., Letartre, X., Pu, M., Oxenløwe, L. K., Yvind, K., & Sciancalepore, C. (2019). Optical frequency comb generation using annealing-free Si₃N₄ films for front-end monolithic integration with Si photonics. In S. M. G-B., & P. C. (Eds.), *Integrated Optics: Devices, Materials, and Technologies XXIII* (Vol. 10921). [1092108] SPIE - International Society for Optical Engineering. Proceedings of SPIE - The International Society for Optical Engineering <https://doi.org/10.1117/12.2508565>

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SPIE.

Event: SPIE OPTO, 2019, San Francisco, California, United States

Optical frequency comb generation using annealing-free Si₃N₄ films for front-end monolithic integration with Si photonics

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ABSTRACT

In this communication, we report on the design, fabrication and testing of silicon-nitride-in-insulator (SiNOI) nonlinear photonic circuits for comb generation in silicon photonics and optoelectronics. The low two-photon absorption when compared with crystalline silicon makes the SiNOI an attractive platform for frequency comb generation. Kerr combs have been recently used in terabit per second coherent communications demos. Such devices can overcome the intrinsic limitations of nowadays silicon photonics notably concerning the heterogeneous integration of III-V on SOI lasers for both datacom and telecom applications. By using monolithically-integrated SiN-based Kerr frequency combs, the generation of tens or even hundreds of new optical frequencies can be obtained in dispersion tailored waveguides and resonators, thus providing an all-optical alternative to the heterointegration of hundreds of standalone III-V on Si lasers. However, in all the previous SiNOI-based frequency combs, the silicon nitride film is annealed under long and high temperature which made the cointegration with silicon based optoelectronics elusive. The annealing steps used in common SiN fabrication processes are not only incompatible with the front-end of line complementary metal-oxide-semiconductor processes, but also costly and long and thus an important cost factor in non-CMOS compatible processes. In our work, we present the fabrication and testing of an annealing-free and crack-free SiNOI. Notably, a 800-nm-spanning (1300-2100 nm) frequency comb is generated using 740-nm-thick silicon nitride featuring full compatibility with silicon photonics integrated circuits. This work constitutes a new, decisive step toward time-stable power-efficient Kerr-based broadband sources featuring full process compatibility with Si photonic integrated circuits (Si-PICs) on CMOS-lines.

Keywords: Complementary metal-oxide-semiconductor (CMOS), nonlinear integrated optics, Kerr-based comb generation, resonators, photonic integrated circuits (PICs), silicon nitride (Si₃N₄).

1. INTRODUCTION

Kerr frequency combs constitute a paradigm shift in the development of high-capacity data transmission, integrated spectroscopy, high precision metrology, and frequency synthesis [1]. Since 2010, silicon-nitride-on-insulator (SiNOI) has imposed as an attractive chip-based platform for the generation of wideband frequency combs pumped at telecom wavelengths, because of its relatively high nonlinearity ($\times 10$ that of silica and larger than that of highly nonlinear Hydex glass [2]) as well as the absence of two-photon absorption and free carrier generation that plague crystalline silicon. In the meanwhile, silicon photonics integrated circuits (Si-PICs) have demonstrated increasing maturity levels for a wide range of optical functions such as III-V-on-Si integrated lasers [3], high-speed modulators [4], Ge-on-Si photodiodes [5], as well as filters and wavelength (de)multiplexers [6], thus continuously highlighting the potential of silicon optoelectronics integration with cost-effective complementary metal-oxide-semiconductor (CMOS) technology [7,8]. In this context, as presented in fig. 1 the monolithic co-integration of Kerr-based frequency combs with Si photonics holds the promise for on-chip high-capacity transmitters that would benefit from the maturity and low cost of CMOS manufacturing and scalability.

The realization of relatively thick (> 700 nm) stoichiometric Si₃N₄ films, as required by microring frequency combs, which imply both a tight confinement of light and anomalous group velocity dispersion (GVD), remains challenging. In particular, all prior works strictly made use of long high-temperature annealing (~ 1200 °C for at least 3h) of the deposited silicon nitride film [9-12]. This extreme annealing step has been accounted for by the need to densify the silicon nitride film through driving out excess hydrogen and break N-H bonds, so as to get closer to a stoichiometric Si₃N₄ film and reduce the material absorption loss in the C-band. However, this annealing induces thermal stress that eventually leads to cracks during the device processing unless sophisticated pre-patterning strategies are adopted prior to the film deposition [10, 11].

Fig. 1. Principles of high transfer rate communications with Kerr frequency combs. Artist's view of a future high transfer rate transmitter, leveraging a Kerr frequency comb source. DeMUX, de-multiplexer; MZ-modulators, Mach-Zehnder modulator; MUX, multiplexer.

Yet, in the context of nonlinear optics-silicon optoelectronics co-integration, these extreme annealing temperatures would severely degrade the front-end silicon optoelectronics circuit underneath. Specifically, doped optical circuits would be unacceptably affected by the undesirable dopant diffusion in junction-based Si modulators and by the hetero-interface degradation of Ge-on-Si photodetectors. Very recently, we reported a new method that avoids thermal annealing for realizing relatively thick (740 nm) crack-free Si₃N₄-based straight nanowaveguides with good linear and nonlinear properties measured by self-phase modulation [15].

2. NONLINEAR SI₃N₄ CIRCUITS FABRICATION

Here, we report for the first time the realization of annealing-free silicon nitride comb microresonators, following a tailored deposition method which minimizes the hydrogen content. Our annealing-free and crack-free fabrication process (shown in Fig. 2) provides our devices with the right specification (microring GVD and characteristics) to underpin Kerr frequency combs, thus representing a significant step toward the full compatibility of Si₃N₄-based Kerr comb sources with the thermal budgets of Si photonics processing. In contrast to all previous approaches, our process does not exceed neither the dopant activation temperature (1030 °C) required for Si modulators [13], nor the H₂ annealing thermal budget used for dislocations control for Ge-on-Si photodiodes (825 °C) [14].

In order to control strain and to prevent cracks from appearing, the silicon nitride layer is deposited on a (non-patterned) substrate via low-pressure chemical vapor deposition (LPCVD) in two steps of 370-nm-thick layer each. The deposition is carried out with a tailored ultra-low deposition rate (~ 2 nm/min) to produce a very high quality film, which is denser optically, and notably offering a higher nonlinear index ($n_2 = 3.6 \times 10^{-19} \text{ m}^2 \cdot \text{W}^{-1}$) [15].

Critically, under such low deposition rates, the thermal activation energy enables silicon and nitrogen to dispose at the nitride film surface via atomic surface migration phenomena, while compelling hydrogen to escape the film. Furthermore, between the two deposition stages, the wafer is rotated by 45° in order to distribute the uniaxial strain along the overall film thickness, thus avoiding film cracks upon subsequent subtractive patterning. Each deposition run is carried out at 780 °C with post-deposition cooling to around 630 °C for 20 minutes. Controlled ramp-ups and -downs from/to 780 °C at 10 °C/minute to/from 630 °C are used prior to each deposition which is carried out under a 112 mTorr pressure using NH₃ (200 sccm) and SiH₂Cl₂ (80 sccm) as precursor gases.

Fig. 2. Schematics of the annealing-free fabrication process for Si₃N₄ nonlinear photonics (a)-(f).

By measuring the wafer bow, before and after removing the silicon nitride from the wafer back side, the material morphological characterization revealed a tensile strain around +1200 MPa. Such high tensile strain is a clear indication of the stoichiometry of the material (i.e., minimization of residual hydrogen content) which is higher than annealed silicon nitrides presented in prior works [11].

The Si₃N₄ circuits were patterned through a combination of deep UV lithography (I-line, 780-nm-thick resist) and fluoride-based (CF₄-CH₂F₂-O₂) dry etching. They were encapsulated by 3-μm-thick SiO₂ cladding layer at 400 °C using high-density plasma-enhanced chemical vapor deposition (HDP-PECVD) to avoid void formation, while a Bosch-like process was used to perform the deep etch for lateral facets patterning. Figs. 3(a), and 3(b) show optical and electron scanning microscope images of the fabricated devices.

Fig. 3. Optical microscope (a) and scanning electron microscope (c) images of the ring and coupling region, respectively. Inset: Cross-section of the void-free coupling gap

3. LINEAR AND NONLINEAR OPTICAL CHARACTERIZATION

The measured spectrum of an annealing-free silicon-nitride-on-insulator microring with a 56- μm radius is shown in Fig. 4. A native line spacing frequency comb spanning across about 730 nm between 1340 nm - 2070 nm was measured when a continuous-wave pump power of ~ 1 W at 1569 nm— was coupled in the bus waveguide. The loaded quality factor of the ring resonator separated by a 350 nm gap from the bus waveguide exceeds 580,000 at the pump wavelength. The cross-section dimensions (1.5- μm -wide $\times$ 740-nm-thick) of the ring ensure that GVD is anomalous at the pump wavelength.

Fig. 4. Comb generation using annealing-free silicon nitride on insulator. A 730-nm-spanning comb generation using a 56- μm -radius Si₃N₄ microresonator.

Interestingly, a slight signature of residual hydrogen-related absorption can be observed in the comb around 1508 nm, but it remains comparable to previous works employing film annealing and does not hinder the generation of a relatively wide and flat comb spectrum.

Another indication of the remaining N-H bonds is provided by the spectral dependence of the intrinsic quality factor (Q_i) measured for a Si₃N₄ micro-ring resonator with 1.4 μm waveguide width (see figure 5). It roughly increases by a factor 2 while moving away from the N-H overtone absorption peak (near 1520 nm), showing the presence of residual N-H bonds in our film. The losses in the ring can be estimated by the expression [16] $\alpha = \frac{k_0 n_g}{Q_i}$ where k_0 is the wavenumber and n_g is the mode group index of the waveguide with similar width. The difference between the losses at 1550 nm ($Q_i = 350,000$) and the losses at 1520 nm ($Q_i = 190,000$) can thus be estimated to be 0.9 dB/cm. This additional loss due to residual N-H absorption for our annealing-free process is comparable to the value (0.6 dB/cm) inferred for high-temperature annealed Si₃N₄ waveguides [17], and, as shown below, it does not preclude the oscillation and comb generation in the C-band.

Fig. 5. Intrinsic quality factor as a function of wavelength for an annealing-free silicon nitride microring resonator (waveguide width equal to 1.4 μm). The darker colored line shows the mean value and the brighter shadowed areas illustrates the standard deviation of the measurements.

The dispersion of our devices is measured by scanning an ECDL light while recording the device transmission and two calibration traces from a fiber cavity and a high-finesse free space cavity with FSR of 171MHz and 175MHz, respectively.

$D_{\text{int}}(\mu) = \omega_{\mu} - D_1\mu = \frac{D_2}{2}\mu^2 + \frac{D_3}{6}\mu^3 + \dots$ is the integrated dispersion where ω_{μ} is the angular frequency, μ is the mode number relative to the pumped mode and D_i are the dispersion coefficients. The measured dispersion is showed in figure 6. A fit of the measured dispersion gives an anomalous dispersion value of $D_2/2\pi = 51 \text{ kHz}$ at 1580 nm which is equivalent to a group velocity dispersion of 29 ps/nm/km. This value compares well with our finite element modeling of the dispersion which gave us an anomalous dispersion estimate of 50 ps/nm/km at the same wavelength. The values of simulated and measured dispersion are in agreement with the simulated dispersion of similar annealed Si₃N₄ waveguides presented in [2].

Fig. 6. Dispersion measurement of the TE mode of a ring resonator with 200 μm radius and 1.5 μm width

In order to measure the threshold power for optical parametric oscillation (OPO), the device was pumped with increasing power levels coupled to the bus waveguide. The laser wavelength was scanned across a resonance at 1570 nm. The chip output light was passed through a short pass filter with a cut-off wavelength of 1560 nm that blocks the pump light with an extinction ratio of 60 dB and was then detected by a photodiode. The peak power of the filtered short wavelength OPO signal at each power coupled to the bus waveguide shows that the measured signal power is plotted in Fig. 7, showing a threshold power of $\sim 83 \text{ mW}$.

Fig. 7. Plot of short-wavelength OPO power with input power in the bus waveguide.

4. CONCLUSIONS

In conclusion, generating a wideband comb at telecom wavelengths using annealing-free silicon nitride nonlinear circuits featuring a full FEOL process compatibility with Si photonics is possible [18]. Via such demonstration, we claim the *first-time realization* of annealing-free silicon nitride frequency comb microresonators, following a tailored deposition method, minimizing the hydrogen content. The right specification (microring group velocity dispersion and characteristics) are provided by our annealing-free and crack-free fabrication process to underpin Kerr frequency combs, thus representing a significant step toward the full compatibility of Si₃N₄-based Kerr-comb sources monolithic integration with standard CMOS and Si photonics processing. Through allowing the monolithic integration of broadband comb sources with CMOS-compatible optoelectronics, our work represents a milestone toward the realization of next-generation Petabit/s data transmitters on a chip.

Funding. DOPT 2020 internal funding program (CEA-LETI). Danish Research Council SPOC (DNRF-123) center of excellence silicon photonics for communications (SPOC) (DTU). ERC H2020 GRAPHICS (648546) and the Institut Universitaire de France (INL).

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